imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



19-3923; Rev 0; 1/06 EVALUATION KIT AVAILABLE SMBus Level 2 Battery Charger with Remote Sense

General Description

The MAX8731 is an SMBus™ programmable multichemistry battery charger. The MAX8731 uses a minimal command set to easily program the charge voltage, charge current, and adapter current limit.

The MAX8731 charges one to four Li+ series cells and delivers up to 8A charge current. The MAX8731 drives n-channel MOSFETs for improved efficiency and reduced cost. Low-offset current-sense amplifiers provide high accuracy with $10m\Omega$ sense resistors.

The MAX8731 current-sense amplifiers provide high accuracy (3% at 3.5A) and also provide fast cycle-bycycle current-mode control to protect against battery short circuit and system load transients.

The charger employs dual remote-sense, which reduces charge time by measuring the feedback voltage directly at the battery, improving accuracy of initial transition into constant-voltage mode. The MAX8731 provides 0.5% battery voltage accuracy directly at the battery terminal.

The MAX8731 provides a digital output that indicates the presence of the AC adapter, as well as an analog output that indicates the adapter current within 4% accuracy.

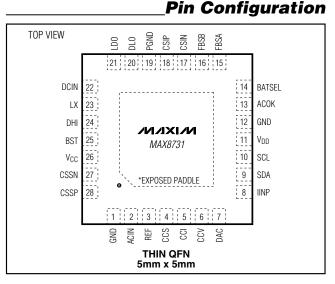
The MAX8731 is available in a small 5mm x 5mm, 28-pin, thin (0.8mm) QFN package. An evaluation kit is available to reduce design time. The MAX8731 is available in lead-free packages.

SMBus is a trademark of Intel Corp.

Applications

Notebook Computers Tablet PCs Medical Devices

Portable Equipment with Rechargeable Batteries



M/IXI/M

_Features

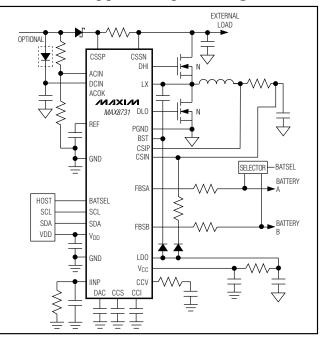
- ♦ 0.5% Battery Voltage Accuracy
- ♦ 3% Input Current-Limit Accuracy
- 3% Charge-Current Accuracy
- SMBus 2-Wire Serial Interface
- Cycle-by-Cycle Current Limit Battery Short-Circuit Protection Fast Response for Pulse Charging Fast System-Load-Transient Response
- Dual-Remote-Sense Inputs
- Monitor Outputs for Adapter Current (4% Accuracy) AC Adapter Detection
- ♦ 11-Bit Battery Voltage Setting
- ♦ 6-Bit Charge-Current/Input-Current Setting
- ♦ 8A (max) Battery Charger Current
- 11A (max) Input Current
- ♦ +8V to +26V Input Voltage Range
- Charges Li+, NiMH, and NiCd Battery Chemistries

_Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX8731ETI+	-40°C to +85°C	28 Thin QFN (5mm x 5mm)

+Indicates lead-free packaging.

Typical Operating Circuit



_ Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

ABSOLUTE MAXIMUM RATINGS

DCIN, CSSN, CSIN, FBSA, FE	SB to GND0.3V to +28V
CSSP to CSSN, CSIP to CSIN	PGND to GND0.3V to +0.3V
BST to GND	0.3V to +32V
BST to LX	0.3V to +6V
DHI to LX	0.3V to +(V _{BST} + 0.3)V
DLO to PGND	0.3V to +(LDO + 0.3)V
LX to GND	6V to +28V
CCI, CCS, CCV, DAC, REF,	
IINP to GND	0.3V to (V _{VCC} + 0.3)V

VDD, SCL, SDA, BATSEL, ACIN, ACOK, V _{CC} to GND,	0.4.
LDO to PGND0.	.3V to +6V
Continuous Power Dissipation ($T_A = +70^{\circ}C$)	
28-Pin Thin QFN	
(derate 20.8mW/°C above +70°C)1	666.7 mW
Operating Temperature Range40°C	℃ to +85°C
Junction Temperature	+150°C
Storage Temperature Range60°C	to +150°C
Lead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{DCIN} = V_{LX} = V_{CSSP} = V_{CSSN} = 19V, V_{BST} - V_{LX} = 4.5V, V_{FBSA} = V_{FBSB} = V_{CSIP} = V_{CSIN} = 16.8V, BATSEL = GND = PGND = 0, C_{LDO} = 1\mu F, V_{CC} = LDO, C_{REF} = 1\mu F, C_{DAC} = 0.1\mu F, V_{DD} = 3.3V, ACIN = 2.5V; pins CCI, CCV, and CCS are compensated per Figure 1; T_A = 0°C to +85°C, unless otherwise noted. Typical values are at T_A = +25°C.)$

PARAMETER	CONDITIONS	MIN	ТҮР	MAX	UNITS
CHARGE-VOLTAGE REGULATION	DN				
	Charging Voltage() 0v/1100	16.716	16.8	16.884	V
	ChargingVoltage() = 0x41A0	-0.5		+0.5	%
	ChargingVoltage() = 0x3130	12.491	12.592	12.693	V
Battery Full-Charge Voltage and	ChargingVoltage() = 0x3130	-0.8		+0.8	%
Accuracy	ChargingVoltage() = 0x20D0	8.333	8.4	8.467	V
		-0.8		+0.8	%
	Charging Voltage() = 0x1060	4.15	4.192	4.234	V
	ChargingVoltage() = 0x1060	-1.0		+1.0	%
Battery Undervoltage-Lockout Trip Point for Trickle Charge			2.5		V
CHARGE-CURRENT REGULATION	DN				
CSIP to CSIN Full-Scale Current- Sense Voltage		78.22	80.64	83.06	mV
	RS2 (Figure 1) = $10m\Omega$;	7.822	8.064	8.306	А
	ChargingCurrent() = 0x1f80	-3		+3	%
	RS2 (Figure 1) = $10m\Omega$;	3.809	3.968	4.126	А
Charge Current and Accuracy	ChargingCurrent() = 0x0f80	-4		+4	%
	RS2 (Figure 1) = $10m\Omega$; ChargingCurrent() = $0x0080$ (128mA)	64		400	mA
Charge-Current Gain Error	Based on ChargeCurrent() = 128mA and 8.064A	-2		+2	%
FBSA/FBSB/CSIP/CSIN Input Voltage Range		0		19	V

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{DCIN} = V_{LX} = V_{CSSP} = V_{CSSN} = 19V, V_{BST} - V_{LX} = 4.5V, V_{FBSA} = V_{FBSB} = V_{CSIP} = V_{CSIN} = 16.8V, BATSEL = GND = PGND = 0, C_{LDO} = 1\mu F, V_{CC} = LDO, C_{REF} = 1\mu F, C_{DAC} = 0.1\mu F, V_{DD} = 3.3V, ACIN = 2.5V; pins CCI, CCV, and CCS are compensated per Figure 1;$ **TA = 0°C to +85°C**, unless otherwise noted. Typical values are at TA = +25°C.)

PARAMETER		CONDITIC	ONS	MIN	ТҮР	MAX	UNITS
Battery Quiescent Current	Adapter present, not charging, $I_{CSIP} + I_{CSIN} + I_{LX} + I_{FBS}$, $V_{FBS} = V_{LX} = V_{CSIN} = V_{CSIP} = 19V$			2	5	μA	
Dattery Quescent Current		Adapter absent, I _{CSIP} + I _{CSIN} + I _{LX} + I _{FBSA} + I _{FBSB} + I _{CSSP} + I _{CSSN} , V _{FBS} = V _{LX} = V _{CSIN} = V _{CSIP} = 19V, V _{DCIN} = 0V				+1	μΛ
		V _{Adapter} = 26V, V _{Ba} charging	attery = 16.8V, not		200	500	μA
Adapter Quiescent Current	IDCIN +	V _{Adapter} = 19V,	Charging		0.4	1	mA
Adapter Quescent Current	ICSSP + ICSSN	V _{Battery} = 16.8V	Not charging		200	500	μA
	100011	V _{Adapter} = 8V,	Charging		0.4	1	mA
		V _{Battery} = 4V	Not charging		200	500	μA
INPUT-CURRENT REGULATION							
CSSP to CSSN Full-Scale Current-Sense Voltage	VFBS_ = 1	9V		106.7	110	113.3	mV
Input Current Accuracy	RS1 (Figur 3584mA	RS1 (Figure 1) = $10m\Omega$, InputCurrent() = $11004mA$ or $3584mA$				+3	%
	RS1 (Figure 1) = $10m\Omega$, InputCurrent() = $2048mA$			-5		+5	%
POR Input Current	RS1 (Figure 1) = $10m\Omega$				256		mA
Input Current-Limit Gain Error	Deceder			-2		+2	%
Input Current-Limit Offset	Based on	InputCurrent() = 1024r	mA and 11004mA	-1		+1	mV
CSSP/CSSN Input Voltage Range				8		26	V
IINP Transconductance	VCSSP - CS	sn = 110mV		2.85	3.0	3.15	mA/V
IINP Offset	Based on	$V_{CSSP} - CSSN = 110m$	/ and 20mV	-1.5		+1.5	mV
	VCSSP - CS	_{SN} = 110mV		-5		+5	
IINP Accuracy	VCSSP - CS	_{SN} = 55mV or 35mV		-4		+4	%
	VCSSP - CSSN = 20mV			-10		+10	
IINP Output Voltage Range				0		3.5	V
SUPPLY AND LINEAR REGULAT	TOR						
DCIN, Input Voltage Range				8.0		26.0	V
DCIN Undervoltage-Lockout	DCIN fallir			7	7.4		V
Trip Point	DCIN risin	g			7.5	7.85	v
Power-Fail Threshold	VCSSP - VC	CSIN falling		9	15	21	mV
	VCSSP - VC	CSIN rising		160	210	271	111V

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{DCIN} = V_{LX} = V_{CSSP} = V_{CSSN} = 19V, V_{BST} - V_{LX} = 4.5V, V_{FBSA} = V_{FBSB} = V_{CSIP} = V_{CSIN} = 16.8V, BATSEL = GND = PGND = 0, C_{LDO} = 1\mu F, V_{CC} = LDO, C_{REF} = 1\mu F, C_{DAC} = 0.1\mu F, V_{DD} = 3.3V, ACIN = 2.5V; pins CCI, CCV, and CCS are compensated per Figure 1; TA = 0°C to +85°C, unless otherwise noted. Typical values are at TA = +25°C.)$

PARAMETER	CONDITIONS	MIN	ТҮР	MAX	UNITS
LDO Output Voltage	$8.0V < V_{DCIN} < 28V$, no load	5.25	5.4	5.55	V
LDO Load Regulation	$0 < I_{LDO} < 30 \text{mA}$		34	100	mV
LDO Undervoltage-Lockout Threshold	$V_{DCIN} = 8.0V, V_{LDO}$ falling	3.20	4	5.15	V
V _{DD} Range		2.7		5.5	V
V _{DD} UVLO Rising			2.5	2.7	V
V _{DD} UVLO Hysteresis			100		mV
V _{DD} Quiescent Current	DCIN < 6V, V _{DD} = 5.5V, SCL = SDA = 5.5V		16	27	μΑ
REFERENCE					
REF Output Voltage	0 < I _{REF} < 500μA	4.071	4.096	4.120	V
REF Undervoltage-Lockout Trip Point	REF falling		3.1	3.9	V
ACOK					
ACOK Sink Current	V _{ACOK} = 0.4V, ACIN = 1.5V	1			mA
ACOK Leakage Current	V _{ACOK} = 5.5V, ACIN = 2.5V			1	μA
ACIN		•			
ACIN Threshold		2.007	2.048	2.089	V
ACIN Threshold Hysteresis		10	20	30	mV
ACIN Input Bias Current		-1		+1	μA
REMOTE-SENSE INPUTS		•			•
FBS_ Range	V _{CSIN} - V _{FBS}	0		200	mV
FBS_ Gain	$\Delta V_{CSIN} / \Delta (V_{CSIN} - V_{FBS})$	0.95	1.00	1.05	V/V
CSIN-FBS_ Clamp Voltage		225	250	275	mV
FBS_ Bias Current	Charger switching, FBS_ selected			14	μA
FBS_ Bias Current	Charger not switching or FBS_ not selected	-2		+2	μA
SWITCHING REGULATOR					
	$V_{CSIN} = 16.0V, V_{CSSP} = 19V$	360	400	440	
Off-Time	$V_{CSIN} = 16.0V, V_{CSSP} = 17V$	260	300	360	ns
BST Supply Current	DHI high		500	800	μA
LX Input Bias Current	V _{DCIN} = 28V, V _{CSIN} = V _{LX} = 20V, DHI low			2	μA
Maximum Discontinuous-Mode Peak Current (I _{MIN})			0.5		А
DHI On-Resistance Low	I _{DHI} = -10mA		1	3	Ω
DHI On-Resistance High	I _{DHI} = 10mA		3	5	Ω
DLO On-Resistance High	I _{DLO} = 10mA		3	5	Ω
DLO On-Resistance Low	$I_{DLO} = -10 \text{mA}$		1	3	Ω

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{DCIN} = V_{LX} = V_{CSSP} = V_{CSSN} = 19V, V_{BST} - V_{LX} = 4.5V, V_{FBSA} = V_{FBSB} = V_{CSIP} = V_{CSIN} = 16.8V, BATSEL = GND = PGND = 0, C_{LDO} = 1\mu F, V_{CC} = LDO, C_{REF} = 1\mu F, C_{DAC} = 0.1\mu F, V_{DD} = 3.3V, ACIN = 2.5V; pins CCI, CCV, and CCS are compensated per Figure 1; TA = 0°C to +85°C, unless otherwise noted. Typical values are at TA = +25°C.)$

PARAMETER		CONDITIONS	MIN	ТҮР	MAX	UNITS
ERROR AMPLIFIERS	·					-
GMV Amplifier Transconductance	ChargingVol	tage() = 16.8V, V _{FBS} = 16.8V	0.0625	0.125	0.2500	mA/V
GMI Amplifier Transconductance	ChargingCu	$rrent() = 3968mA, V_{CSIP} - V_{CSIN} = 39.68mV$	0.5	1	2.0	mA/V
GMS Amplifier Transconductance	InputCurren	t() = 3968mA, V _{CSSP} - V _{CSSN} = 79.36mV	0.5	1	2.0	mA/V
CCI/CCS/CCV Clamp Voltage	$0.25V < V_{CO}$	CI/S/V < 2.0V	120	250	600	mV
LOGIC LEVELS						
SDA/SCL Input Low Voltage	$V_{DD} = 2.7 V$	to 5.5V			0.8	V
SDA/SCL Input High Voltage	$V_{DD} = 2.7V$	to 5.5V	2.1			V
SDA/SCL Input Bias Current	$V_{DD} = 2.7 V$	to 5.5V	-1		+1	μA
BATSEL Input Low Voltage					0.8	V
BATSEL Input High Voltage			2.1			V
BATSEL Input Bias Current			-1		+1	μA
SDA, Output Sink Current	V(SDA) = 0.4	łV	6			mA
SMBus TIMING SPECIFICATION	S (V _{DD} = 2.7V	to 5.5V) (see Figures 4 and 5)				
PARAMETERS	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
SMBus Frequency	fSMB		10		100	kHz
Bus Free Time	tBUF		4.7			μs
Start Condition Hold Time from SCL	thd:sta		4			μs
Start Condition Setup Time from SCL	tsu:sta		4.7			μs
Stop Condition Setup Time from SCL	tsu:sto		4			μs
SDA Hold Time from SCL	thd:dat		300			ns
SDA Setup Time from SCL	tsu:dat		250			ns
SCL Low Timeout	TIMEOUT	(Note 1)	25		35	ms
SCL Low Period	TLOW		4.7			μs
SCL High Period	THIGH		4			μs
Maximum Charging Period Without a ChargeVoltage() or ChargeCurrent() Command			140	175	210	S

ELECTRICAL CHARACTERISTICS

 $(V_{DCIN} = V_{LX} = V_{CSSP} = V_{CSSN} = 19V, V_{BST} - V_{LX} = 4.5V, V_{FBSA} = V_{FBSB} = V_{CSIP} = V_{CSIN} = 16.8V, BATSEL = GND = PGND = 0, C_{LDO} = 1\muF, V_{CC} = LDO, C_{REF} = 1\muF, C_{DAC} = 0.1\muF, V_{DD} = 3.3V, ACIN = 2.5V; pins CCI, CCV, and CCS are compensated per Figure 1;$ **TA = -40°C to +85°C**, unless otherwise noted.) (Note 2)

PARAMETER		CONDITIC	INS	MIN	ТҮР	MAX	UNITS
CHARGE-VOLTAGE REGULATION	N			•			
				16.632		16.968	V
	Chargingv	oltage() = 0x41A0		-1		+1	%
				12.466		12.717	V
Battery Full-Charge Voltage and	Chargingv	oltage() = 0x3130		-1		+1	%
Accuracy				8.316		8.484	V
	Chargingv	oltage() = 0x20D0		-1		+1	%
				4.129		4.255	V
	Chargingv	oltage() = 0x1060		-1.5		+1.5	%
CHARGE-CURRENT REGULATION	ON						
CSIP to CSIN Full-Scale Current- Sense Voltage				78.22		83.05	mV
	RS2 (Figure 1) = $10m\Omega$;			7.822		8.305	А
	ChargingC	ChargingCurrent()= 0x1f80				+3	%
	RS2 (Figur	RS2 (Figure 1) = $10m\Omega$;				4.126	А
Charge Current and Accuracy	ChargingCurrent() = 0x0f80			-4		+4	%
	RS2 (Figure 1) =10mΩ; ChargingCurrent() = 0x0080			30		400	mA
Charge-Current Gain Error	Based on (ChargeCurrent() = 128	3mA and 8.064A	-2		+2	%
FBSA/FBSB/CSIP/CSIN Input Voltage Range				0		19	V
		esent, not charging, l x = V _{CSIN} = V _{CSIP} =	CSIP + I _{CSIN} + I _{LX} + I _{FBS} , 19V			5	
Battery Quiescent Current	Adapter absent, I _{CSIP} + I _{CSIN} + I _{LX} + I _{FBSA} + I _{FBSB} + I _{CSSP} + I _{CSSN} , V _{FBS} = V _{LX} = V _{CSIP} = 19V, V _{DCIN} = 0V				1	μA	
		V _{Adapter} = 26V, V _{Bat}	tery = 16.8V, not charging			500	μA
	IDCIN +	V _{Adapter} = 19V,	Charging			1	mA
Adapter Quiescent Current	ICSSP +	V _{Battery} = 16.8V	Not charging			500	μA
	ICSSN	V _{Adapter} = 8V,	Charging			1	mA
		$V_{Battery} = 4V$	Not charging			500	μA

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{DCIN} = V_{LX} = V_{CSSP} = V_{CSSN} = 19V, V_{BST} - V_{LX} = 4.5V, V_{FBSA} = V_{FBSB} = V_{CSIP} = V_{CSIN} = 16.8V, BATSEL = GND = PGND = 0, C_{LDO} = 1\mu F, V_{CC} = LDO, C_{REF} = 1\mu F, C_{DAC} = 0.1\mu F, V_{DD} = 3.3V, ACIN = 2.5V; pins CCI, CCV, and CCS are compensated per Figure 1;$ **TA = -40°C to +85°C**, unless otherwise noted.) (Note 2)

PARAMETER	CONDITIONS	MIN	ТҮР	МАХ	UNITS
INPUT-CURRENT REGULATION	•	•			
CSSP to CSSN Full-Scale Current-Sense Voltage	VFBS_ = 19V	103.3		116.6	mV
	RS1 (Figure 1) = $10m\Omega$; InputCurrent() = $11004mA$ or $3584mA$	-6		+6	0/
Input Current Accuracy	RS1 (Figure 1) = 10mΩ; InputCurrent() = 2048mA	-5		+5	%
Input Current-Limit Gain Error	Based on InputCurrent() = 1024mA and 11004mA	-5		+5	%
Input Current-Limit Offset	Based on InputCurrent() = 1024mA and 11004mA	-1		+1	mV
CSSP/CSSN Input Voltage Range		8		26	V
IINP Transconductance	V _{CSSP - CSSN} = 110mV	2.7		3.3	mA/V
IINP Offset	Based on $V_{CSSP - CSSN} = 110 \text{mV}$ and 20mV	-1.5		+1.5	mV
	V _{CSSP} - _{CSSN} = 110mV	-5		+5	
IINP Accuracy	V _{CSSP} - _{CSSN} = 55mV or 35mV	-4		+4	%
	V _{CSSP} - _{CSSN} = 20mV	-10		+10	
IINP Output Voltage Range		0		3.5	V
SUPPLY AND LINEAR REGULAT	OR	•			
DCIN, Input Voltage Range		8.0		26.0	V
DCIN Undervoltage-Lockout	DCIN falling	7			
Trip Point	DCIN rising			7.85	V
	V _{CSSP} - V _{CSIN} falling	9		21	
POWER_FAIL Threshold	V _{CSSP} - V _{CSIN} rising	160		271	mV
LDO Output Voltage	8.0V < V _{DCIN} < 28V, no load	5.25		5.55	V
LDO Load Regulation	$0 < I_{LDO} < 30 \text{mA}$			100	mV
LDO Undervoltage-Lockout Threshold	V _{DCIN} = 8.0V, V _{LDO} falling	3.20		5.15	V
V _{DD} Range		2.7		5.5	V
V _{DD} UVLO Rising				2.7	V
V _{DD} Quiescent Current	DCIN < 6V, V _{DD} = 5.5V, SCL = SDA = 5.5V			27	μA
REFERENCE					
REF Output Voltage	0 < I _{REF} < 500μA	4.053		4.139	V
REF Undervoltage-Lockout Trip Point	REF falling			3.9	V
ACOK	1	I			1
ACOK Sink Current	$V_{ACOK} = 0.4V, ACIN = 1.5V$	1			mA

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{DCIN} = V_{LX} = V_{CSSP} = V_{CSSN} = 19V, V_{BST} - V_{LX} = 4.5V, V_{FBSA} = V_{FBSB} = V_{CSIP} = V_{CSIN} = 16.8V, BATSEL = GND = PGND = 0, C_{LDO} = 1\muF, V_{CC} = LDO, C_{REF} = 1\muF, C_{DAC} = 0.1\muF, V_{DD} = 3.3V, ACIN = 2.5V; pins CCI, CCV, and CCS are compensated per Figure 1; TA = -40°C to +85°C, unless otherwise noted.) (Note 2)$

PARAMETER	CONDITIONS	MIN	ТҮР	MAX	UNITS
ACIN	•	•			
ACIN Threshold		2.007		2.089	V
ACIN Threshold Hysteresis		10		30	mV
REMOTE-SENSE INPUTS					
FBS_ Range	V _{CSIN} - V _{FBS}	0		200	mV
FBS_ Gain	$\Delta V_{CSIN} / \Delta (V_{CSIN} - V_{FBS_})$	0.9		1.1	V/V
CSIN-FBS_ Clamp Voltage		220		280	mV
FBS_ Bias Current	Charger switching, FBS_ selected			14	μA
SWITCHING REGULATOR					
0# Time -	$V_{CSIN} = 16.0V, V_{CSSP} = 19V$	360		440	
Off-Time	$V_{CSIN} = 16.0V, V_{CSSP} = 17V$	260		350	ns
BST Supply Current	DHI high			800	μΑ
DHI On-Resistance Low	I _{DHI} = -10mA			3	Ω
DHI On-Resistance High	I _{DHI} = 10mA			5	Ω
DLO On-Resistance High	I _{DLO} = 10mA			5	Ω
DLO On-Resistance Low	I _{DLO} = -10mA			3	Ω
ERROR AMPLIFIERS					
GMV Amplifier Transconductance	ChargingVoltage() = 16.8V, V _{FBS} = 16.8V	0.0625		0.2500	mA/V
GMI Amplifier Transconductance	ChargingCurrent() = 3968mA, V _{CSIP} - V _{CSIN} = 39.68mV	0.5		2.0	mA/V
GMS Amplifier Transconductance	InputCurrent() = 3968mA, V _{CSSP} - V _{CSSN} = 79.36mV	0.5		2.0	mA/V
CCI/CCS/CCV Clamp Voltage	$0.25V < V_{CCI/S/V} < 2.0V$	150		600	mV
LOGIC LEVELS					
SDA/SCL Input Low Voltage	$V_{DD} = 2.7V$ to 5.5V			0.8	V
SDA/SCL Input High Voltage	$V_{DD} = 2.7V$ to 5.5V	2.3			V
BATSEL Input Low Voltage				0.8	V
BATSEL Input High Voltage		2.3			V
SDA, Output Sink Current	$V_{(SDA)} = 0.4V$	6			mA

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{DCIN} = V_{LX} = V_{CSSP} = V_{CSSN} = 19V, V_{BST} - V_{LX} = 4.5V, V_{FBSA} = V_{FBSB} = V_{CSIP} = V_{CSIN} = 16.8V, BATSEL = GND = PGND = 0, C_{LDO} = 1\mu F, V_{CC} = LDO, C_{REF} = 1\mu F, C_{DAC} = 0.1\mu F, V_{DD} = 3.3V, ACIN = 2.5V; pins CCI, CCV, and CCS are compensated per Figure 1; TA = -40°C to +85°C, unless otherwise noted.) (Note 2)$

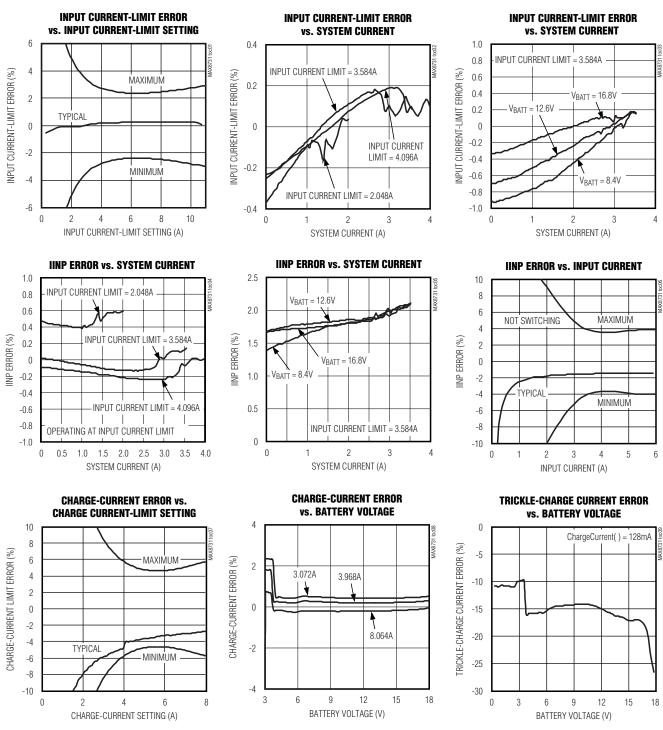
SMB TIMING SPECIFICATION (VDD = 2.7V to 5.5V) (see Figures 4 and 5)						
PARAMETERS	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
SMBus Frequency	fSMB		10		100	kHz
Bus Free Time	tBUF		4.7			μs
Start Condition Hold Time from SCL	thd:sta		4			μs
Start Condition Setup Time from SCL	tsu:sta		4.7			μs
Stop Condition Setup Time from SCL	tsu:sto		4			μs
SDA Hold Time from SCL	thd:dat		300			ns
SDA Setup Time from SCL	tsu:dat		250			ns
SCL Low Timeout	TIMEOUT	(Note 1)	25		35	ms
SCL Low Period	TLOW		4.7			μs
SCL High Period	THIGH		4			μs
Maximum Charging Period Without a ChargeVoltage() or ChargeCurrent() Command			140		210	S

Note 1: Devices participating in a transfer will timeout when any clock low exceeds the 25ms minimum timeout period. Devices that have detected a timeout condition must reset the communication no later than the 35ms maximum timeout period. Both a master and a slave must adhere to the maximum value specified as it incorporates the cumulative stretch limit for both a master (10ms) and a slave (25ms).

Note 2: Specifications to -40°C are guaranteed by design, not production tested.

(Circuit of Figure 1, adapter = 19.5V, ChargeVoltage() = 16.8V, ChargeCurrent() = 3.854A, InputCurrent() = 3.584A, T_A = +25°C, unless otherwise noted.)

Typical Operating Characteristics

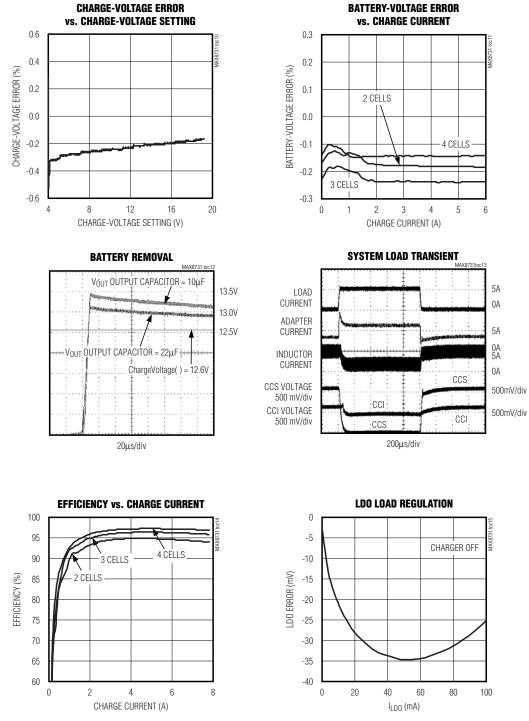


10

MAX873

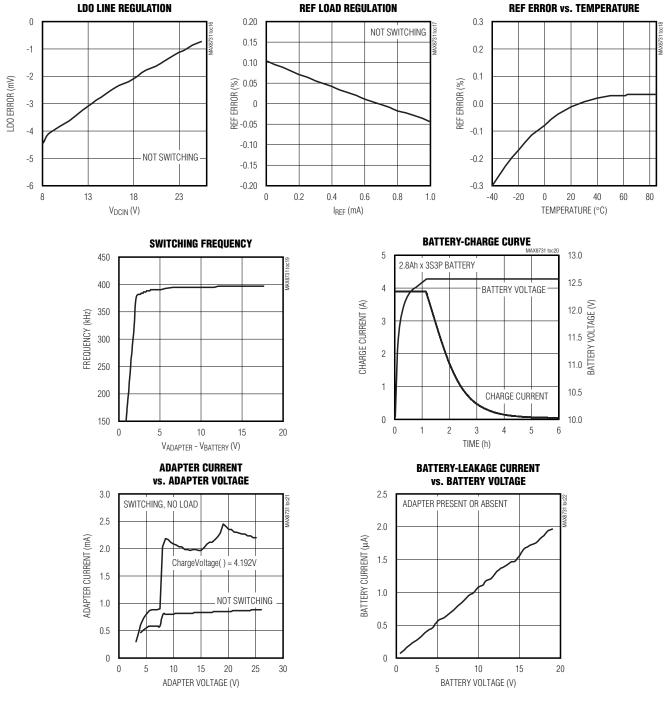
Typical Operating Characteristics (continued)

(Circuit of Figure 1, adapter = 19.5V, ChargeVoltage() = 16.8V, ChargeCurrent() = 3.854A, InputCurrent() = 3.584A, T_A = $+25^{\circ}C$, unless otherwise noted.)



Typical Operating Characteristics (continued)

(Circuit of Figure 1, adapter = 19.5V, ChargeVoltage() = 16.8V, ChargeCurrent() = 3.854A, InputCurrent() = 3.584A, T_A = $+25^{\circ}C$, unless otherwise noted.)



MAX8731

_Pin Description

PIN	NAME	FUNCTION
1, 12	GND	Analog Ground. Connect directly to the paddle.
2	ACIN	AC Adapter Detect Input. ACIN is the input to an uncommitted comparator.
3	REF	4.096V Voltage Reference. Bypass REF with a 1µF capacitor to GND.
4	CCS	Input Current Regulation Loop-Compensation Point. Connect 0.01µF from CCS to GND.
5	CCI	Output Current Regulation Loop-Compensation Point. Connect 0.01µF from CCI to GND.
6	CCV	Voltage Regulation Loop-Compensation Point. Connect $10k\Omega$ in series with 0.01µF to GND.
7	DAC	DAC Voltage Output. Bypass with 0.1µF from DAC to GND.
8	IINP	Input Current Monitor Output. IINP sources the current proportional to the current sensed across CSSP and CSSN. The transconductance from (CSSP - CSSN) to IINP is 3mA/V.
9	SDA	SMBus Data I/O. Open-drain output. Connect an external pullup resistor according to SMBus specifications.
10	SCL	SMBus Clock Input. Connect an external pullup resistor according to SMBus specifications.
11	V _{DD}	Logic Circuitry Supply-Voltage Input. Bypass with a 0.1µF capacitor to GND.
13	ACOK	AC Detect Output. This open-drain output is high impedance when ACIN is greater than REF/2. The ACOK output remains low when the MAX8731 is powered down. Connect a $10k\Omega$ pullup resistor from V _{CC} to ACOK.
14	BATSEL	Battery Voltage Select Input. Drive BATSEL high to select battery B, or drive BATSEL low to select battery A. Any change of BATSEL immediately stops charging. Charging begins again in approximately 10ms.
15	FBSA	Remote Sense Input for the Output Voltage of Battery A. Connect a 100Ω resistor from FBSA to the battery connector, and a 10nF capacitor from FBSA to PGND.
16	FBSB	Remote Sense Input for the Output Voltage of Battery B. Connect a 100Ω resistor from FBSB to the battery connector, and a 10nF capacitor from FBSB to PGND.
17	CSIN	Charge Current-Sense Negative Input
18	CSIP	Charge Current-Sense Positive Input. Connect a $10m\Omega$ current-sense resistor between CSIP and CSIN.
19	PGND	Power Ground
20	DLO	Low-Side Power MOSFET Driver Output. Connect to low-side n-channel MOSFET. DLO drives between LDO and PGND.
21	LDO	Linear-Regulator Output. LDO is the output of the 5.4V linear regulator supplied from DCIN. LDO also directly supplies the DLO driver and the BST charge pump. Bypass with a 1µF ceramic capacitor from LDO to PGND.
22	DCIN	Charger Bias Supply Input. Bypass DCIN with a 0.1µF capacitor to PGND.
23	LX	High-Side Power MOSFET Driver Source Connection. Connect to the source of the high-side n-channel MOSFET.
24	DHI	High-Side Power MOSFET Driver Output. Connect to the high-side n-channel MOSFET gate.
25	BST	High-Side Power MOSFET Driver Power-Supply Connection. Connect a 0.1µF capacitor from BST to LX.
26	Vcc	Device Power-Supply Input. Connect to LDO through an RC filter as shown in Figure 1.
27	CSSN	Input Current-Sense Negative Input
28	CSSP	Input Current-Sense Positive Input. Connect a $10m\Omega$ current-sense resistor between CSSP and CSSN.
29	BP	Backside Paddle. Connect the backside paddle to analog ground.

MAX8731

MAX8731

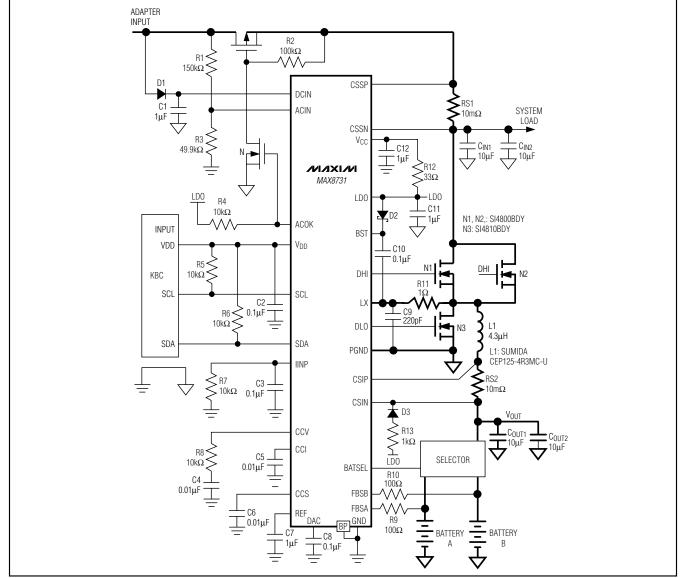


Figure 1. Typical Dual-Battery Application Circuit

Detailed Description

The typical operating circuit is shown in Figure 1. The MAX8731 includes all the functions necessary to charge Li+, NiMH, and NiCd smart batteries. A high-efficiency, synchronous-rectified, step-down DC-DC converter is used to implement a precision constant-current, constant-voltage charger. The DC-DC converter drives a high-side n-channel MOSFET and provides synchronous rectification with a low-side n-channel MOSFET. The charge current and input current-sense

amplifiers have low input-offset error ($\pm 64\mu V$ typ), allowing the use of small-valued sense resistors.

The MAX8731 features a voltage-regulation loop (CCV) and two current-regulation loops (CCI and CCS). The loops operate independently of each other. The CCV voltage-regulation loop monitors either FBSA or FBSB to ensure that its voltage never exceeds the voltage set by the ChargeVoltage() command. The CCI battery current-regulation loop monitors current delivered to the selected battery to ensure that it never exceeds the current limit set by the ChargeCurrent() command. The



charge current-regulation loop is in control as long as the selected battery voltage is below the charge voltage set point. When the selected battery voltage reaches its set point, the voltage-regulation loop takes control and maintains the battery voltage at the set point. A third loop (CCS) takes control and reduces the charge current when the adapter current exceeds the input current limit set by the InputCurrent() command.

A functional diagram is shown in Figure 2.

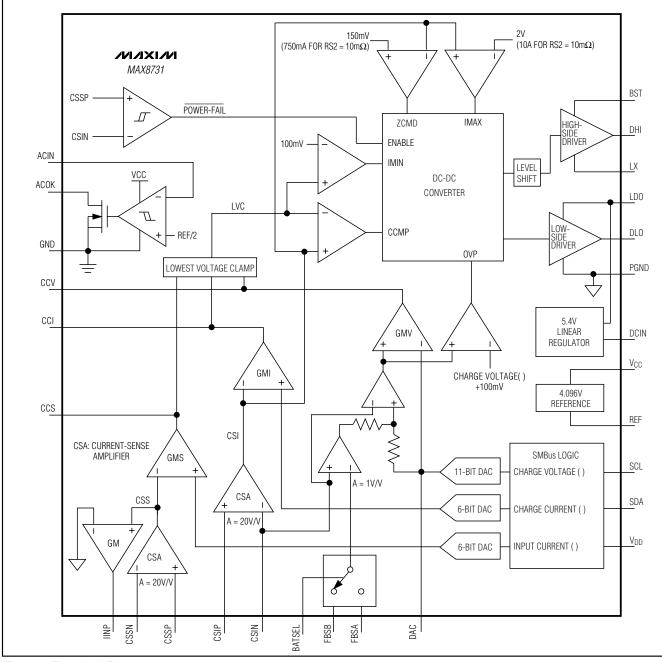


Figure 2. Functional Diagram



MAX8731

Setting Charge Voltage

To set the output voltage, use the SMBus to write a 16bit ChargeVoltage() command using the data format listed in Table 1. The ChargeVoltage() command uses the Write-Word protocol (see Figure 3). The command code for ChargeVoltage() is 0x15 (0b00010101). The MAX8731 provides a 1.024V to 19.200V charge voltage range, with 16mV resolution. Set ChargeVoltage() below 1.024V to terminate charging. Upon reset, the ChargeVoltage() and ChargeCurrent() values are cleared and the charger remains off until both the ChargeVoltage() and the ChargeCurrent() command are sent. Both DHI and DLO remain low until the charger is restarted.

Table 1. ChargeVoltage () (0x15)

BIT	BIT NAME	DESCRIPTION	
0	—	Not used. Normally a 1mV weight.	
1	—	Not used. Normally a 2mV weight.	
2		Not used. Normally a 4mV weight.	
3		Not used. Normally a 8mV weight.	
4	Charge voltage, DACV 0	0 = Adds 0mV of charger voltage compliance, 1024mV min.1 = Adds 16mV of charger voltage compliance.	
5	Charge voltage, DACV 1	0 = Adds 0mV of charger voltage compliance, 1024mV min. 1 = Adds 32mV of charger voltage compliance.	
6	Charge voltage, DACV 2	0 = Adds 0mV of charger voltage compliance, 1024mV min. 1 = Adds 64mV of charger voltage compliance.	
7	Charge voltage, DACV 3	0 = Adds 0mV of charger voltage compliance, 1024mV min. 1 = Adds 128mV of charger voltage compliance.	
8	Charge voltage, DACV 4	0 = Adds 0mV of charger voltage compliance, 1024mV min. 1 = Adds 256mV of charger voltage compliance.	
9	Charge voltage, DACV 5	0 = Adds 0mV of charger voltage compliance, 1024mV min. 1 = Adds 512mV of charger voltage compliance.	
10	Charge voltage, DACV 6	0 = Adds 0mA of charger voltage compliance. 1 = Adds 1024mV of charger voltage compliance.	
11	Charge voltage, DACV 7	0 = Adds 0mV of charger voltage compliance. 1 = Adds 2048mV of charger voltage compliance.	
12	Charge voltage, DACV 8	0 = Adds 0mV of charger voltage compliance. 1 = Adds 4096mV of charger voltage compliance.	
13	Charge voltage, DACV 9	0 = Adds 0mV of charger voltage compliance.1 = Adds 8192mV of charger voltage compliance.	
14	Charge voltage, DACV 10	0 = Adds 0mV of charger voltage compliance. 1 = Adds 16,384mV of charger voltage compliance, 19,200mV max.	
15	_	Not used. Normally a 32,768mV weight.	

M/IXI/M

Setting Charge Current

To set the charge current, use the SMBus to write a 16bit ChargeCurrent() command using the data format listed in Table 2. The ChargeCurrent() command uses the Write-Word protocol (see Figure 3). The command code for ChargeCurrent() is 0x14 (0b00010100). When RS2 =10m Ω , the MAX8731 provides a charge current range of 128mA to 8.064A, with 128mA resolution. Set ChargeCurrent() to 0 to terminate charging. Upon reset, the ChargeVoltage() and ChargeCurrent() values are cleared and the charger remains off until both the ChargeVoltage() and the ChargeCurrent() commands are sent. Both DHI and DLO remain low until the charger is restarted.

The MAX8731 includes a foldback current limit when the battery voltage is low. If the battery voltage is less than 2.5V, the charge current is temporarily set to 128mA. The ChargeCurrent() register is preserved and becomes active again when the battery voltage is higher than 2.5V. This function effectively provides a foldback current limit, which protects the charger during short circuit and overload.

Setting Input Current Limit

System current normally fluctuates as portions of the system are powered up or put to sleep. By using the input-current-limit circuit, the output-current requirement of the AC wall adapter can be lowered, reducing system cost.

The total input current, from a wall cube or other DC source, is the sum of the system supply current and the current required by the charger. When the input current exceeds the set input current limit, the MAX8731 decreases the charge current to provide priority to system load current. As the system supply rises, the available charge current drops linearly to zero. Thereafter, the total input current can increase without limit.

The internal amplifier compares the differential voltage between CSSP and CSSN to a scaled voltage set by the InputCurrent() command (see Table 3). The total input current is the sum of the device supply current, the charger input current, and the system load current. The total input current can be estimated as follows:

BIT	BIT NAME	DESCRIPTION	
0	_	Not used. Normally a 1mA weight.	
1	_	Not used. Normally a 2mA weight.	
2	—	Not used. Normally a 4mA weight.	
3		Not used. Normally an 8mA weight.	
4		Not used. Normally a 16mA weight.	
5	_	Not used. Normally a 32mA weight.	
6		Not used. Normally a 64mA weight.	
7	Charge Current, DACI 0	0 = Adds 0mA of charger current compliance.1 = Adds 128mA of charger current compliance.	
8	Charge Current, DACI 1	0 = Adds 0mA of charger current compliance.1 = Adds 256mA of charger current compliance.	
9	Charge Current, DACI 2	0 = Adds 0mA of charger current compliance.1 = Adds 512mA of charger current compliance.	
10	Charge Current, DACI 3	0 = Adds 0mA of charger current compliance.1 = Adds 1024mA of charger current compliance.	
11	Charge Current, DACI 4	0 = Adds 0mA of charger current compliance.1 = Adds 2048mA of charger current compliance.	
12	Charge Current, DACI 5	0 = Adds 0mA of charger current compliance.1 = Adds 4096mA of charger current compliance, 8064mA max.	
13		Not used. Normally a 8192mA weight.	
14		Not used. Normally a 16,386mA weight.	
15		Not used. Normally a 32,772mA weight.	

Table 2. ChargeCurrent() (0x14) (10m Ω Sense Resistor, RS2)

Remote Sense

 $I_{\text{INPUT}} = I_{\text{LOAD}} + \left[\frac{\left(I_{\text{CHARGE}} \times V_{\text{BATTERY}}\right)}{\left(V_{\text{IN}} \times \eta\right)}\right] + I_{\text{BIAS}}$

where η is the efficiency of the DC-DC converter (typically 85% to 95%).

To set the input current limit, use the SMBus to write a 16-bit InputCurrent() command using the data format listed in Table 3. The InputCurrent() command uses the Write-Word protocol (see Figure 3). The command code for InputCurrent() is 0x3F (0b00111111). When RS1 = 10m Ω , the MAX8731 provides an input-current-limit range of 256mA to 11.004A, with 256mA resolution. InputCurrent() settings from 1mA to 256mA result in a current limit of 256mA. Upon reset the input current limit is 256mA.

Charger Timeout

The MAX8731 includes a timer to terminate charging if the charger does not receive a ChargeVoltage() or ChargeCurrent() command within 175s. If a timeout occurs, both ChargeVoltage() and ChargeCurrent() commands must be resent to reenable charging. The MAX8731 features dual remote sense, which allows the rejection of board resistance and selector resistance when used in either single- or dual-battery systems. To fully utilize remote sensing, connect FBS_ directly to the battery interface through an unshared battery sense trace in series with a 100 Ω resistor, and 10nF capacitor (see Figure 1). In single-battery systems, connect BATSEL directly to GND and use only FBSA.

Remote sensing cancels the effect of impedance in series with the battery. This impedance normally causes the battery charger to prematurely enter constantvoltage mode with reducing charge current. The result is that the last 20% of charging takes longer than necessary. When in constant-voltage mode, the remaining charge time is proportional to the total resistance in series with the battery. Remote sensing reduces charge time according to the following equation:

$$t_{CVRS} = t_{CV0} \times \frac{R_{Pack}}{R_{Pack} + R_{Board}}$$

BIT BIT NAME		DESCRIPTION		
0	_	Not used. Normally a 2mA weight.		
1		Not used. Normally a 4mA weight.		
2	_	Not used. Normally an 8mA weight.		
3		Not used. Normally a 16mA weight.		
4		Not used. Normally a 32mA weight.		
5	_	Not used. Normally a 64mA weight.		
6		Not used. Normally a 128mA weight.		
7	Input Current, DACS 0	0 = Adds 0mA of input current compliance.1 = Adds 256mA of input current compliance.		
8	Input Current, DACS 1	0 = Adds 0mA of input current compliance.1 = Adds 512mA of input current compliance.		
9	Input Current, DACS 2	0 = Adds 0mA of input current compliance. 1 = Adds 1024mA of input current compliance.		
10	Input Current, DACS 3	0 = Adds 0mA of input current compliance.1 = Adds 2048mA of input current compliance.		
11	Input Current, DACS 4	0 = Adds 0mA of input current compliance.1 = Adds 4096mA of input current compliance.		
12	Input Current, DACS 5	0 = Adds 0mA of input current compliance. 1 = Adds 8192mA of input current compliance, 11,004mA max.		
13		Not used. Normally a 16,384mA weight.		
14		Not used. Normally a 32,768mA weight.		
15	_	Not used. Normally a 65,536mA weight.		

Table 3. InputCurrent() (0x3F) (10m Ω Sense Resistor, RS1)



MAX8731

SMBus Level 2 Battery Charger with Remote Sense

VDD Supply

where R_{Pack} is the total resistance in the battery pack, R_{Board} is the board resistance in series with the battery charge path, t_{CV0} is the constant-voltage charge time without remote sense, and t_{CVRS} is the constant-voltage charge time with remote sense.

The MAX8731 includes a safety feature, which limits the charge voltage when FBS_ or the selector is disconnected. The MAX8731 guarantees that CSIN does not regulate more than 200mV above the selected charging voltage. This also limits the extent to which remote sense can cancel charge-path impedance.

Input Current Measurement

Use IINP to monitor the system-input current sensed across CSSP and CSSN. The voltage at IINP is proportional to the input current by the equation:

VIINP = IINPUT x RS1 x GIINP x R8

where IINPUT is the DC current supplied by the AC adapter, G_{IINP} is the transconductance of IINP (3mA/V typ), and R8 is the resistor connected between IINP and ground. Typically, IINP has a 0 to 3.5V output voltage range. Leave IINP open if not used.

LDO Regulator

An integrated low-dropout (LDO) linear regulator provides a 5.4V supply derived from DCIN, and delivers over 30mA of load current. The LDO powers the gate drivers of the n-channel MOSFETs. See the *MOSFET Drivers* section. LDO has a minimum current limit of 35mA. This allows the MAX8731 to work with 87nC of total gate charge (both high-side and low-side MOSFETs). Bypass LDO to PGND with a 1µF or greater ceramic capacitor.

AC Adapter Detection

The MAX8731 includes a hysteretic comparator that detects the presence of an AC power adapter. When ACIN is greater than 2.048V, the open-drain ACOK output becomes high impedance. Connect $10k\Omega$ pullup resistance between LDO and ACOK. Use a resistive voltage-divider from the adapter's output to the ACIN pin to set the appropriate detection threshold. Select the resistive voltage-divider not to exceed the 6V absolute maximum rating of ACIN.

The V_{DD} input provides power to the SMBus interface. Connect V_{DD} to LDO, or apply an external supply to V_{DD} to keep the SMBus interface active while the supply to DCIN is removed. When V_{DD} is biased the internal registers are maintained. Bypass V_{DD} to GND with a 0.1μ F or greater ceramic capacitor.

Operating Conditions

The MAX8731 has the following operating states:

• Adapter Present: When DCIN is greater than 7.5V, the adapter is considered to be present. In this condition, both the LDO and REF function properly and battery charging is allowed:

a) Charging: The total MAX8731 quiescent current when charging is 1mA (max) plus the current required to drive the MOSFETs.

b) Not Charging: To disable charging, set either ChargeCurrent() or ChargeVoltage() to zero. When the adapter is present and charging is disabled, the total adapter quiescent current is less than 1mA and the total battery quiescent current is less than 5µA.

- Adapter Absent (Power Fail): When V_{CSSP} is less than V_{CSIN} + 10mV, the MAX8731 is in the power-fail state, since the DC-DC converter is in dropout. The charger does not attempt to charge in the power-fail state. Typically, this occurs when the adapter is absent. When the adapter is absent, the total MAX8731 quiescent battery current is less than 1µA (max).
- VDD Undervoltage (POR): When VDD is less than 2.5V, the VDD supply is in an undervoltage state and the internal registers are in their POR state. The SMBus interface does not respond to commands. When VDD rises above 2.5V, the MAX8731 is in a power-on reset state. Charging does not occur until the ChargeVoltage() and ChargeCurrent() commands are sent. When VDD is greater than 2.5V, SMBus registers are preserved.

The MAX8731 allows charging under the following conditions:

- 1) DCIN > 7.5V, LDO > 4V, REF > 3.1V
- 2) VCSSP > VCSIN + 210mV (15mV falling threshold)
- 3) $V_{DD} > 2.5V$

SMBus Interface

The MAX8731 receives control inputs from the SMBus interface. The MAX8731 uses a simplified subset of the commands documented in System Management Bus Specification V1.1, which can be downloaded from www.smbus.org. The MAX8731 uses the SMBus Read-Word and Write-Word protocols (Figure 3) to communicate with the smart battery. The MAX8731 performs only as an SMBus slave device with address 0b0001001_ (0x12) and does not initiate communication on the bus. In addition, the MAX8731 has two identification (ID) registers (0xFE): a 16-bit device ID register and a 16-bit manufacturer ID register (0xFF).

The data (SDA) and clock (SCL) pins have Schmitt-trigger inputs that can accommodate slow edges. Choose pullup resistors ($10k\Omega$) for SDA and SCL to achieve rise times according to the SMBus specifications.

Communication starts when the master signals a START condition, which is a high-to-low transition on SDA, while SCL is high. When the master has finished communicating, the master issues a STOP condition, which is a low-to-high transition on SDA, while SCL is high. The bus is then free for another transmission. Figures 4 and 5 show the timing diagram for signals on the SMBus interface. The address byte, command byte, and data bytes are transmitted between the START and STOP conditions. The SDA state changes only while SCL is low, except for the START and STOP conditions. Data is transmitted in 8-bit bytes and is sampled on the rising edge of SCL. Nine clock cycles are required to transfer each byte in or out of the MAX8731 because either the master or the slave acknowledges the receipt of the correct byte during the ninth clock cycle. The MAX8731 supports the charger commands as described in Table 4.

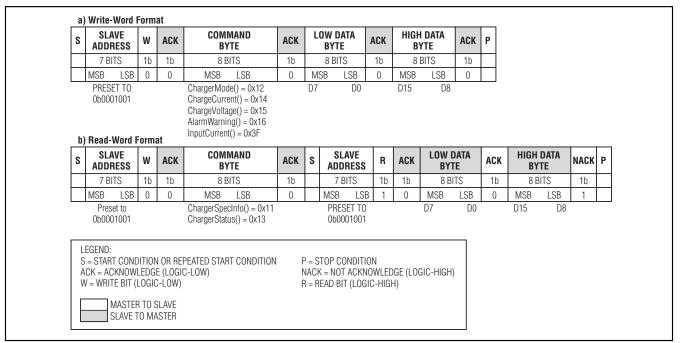


Figure 3. SMBus Write-Word and Read-Word Protocols

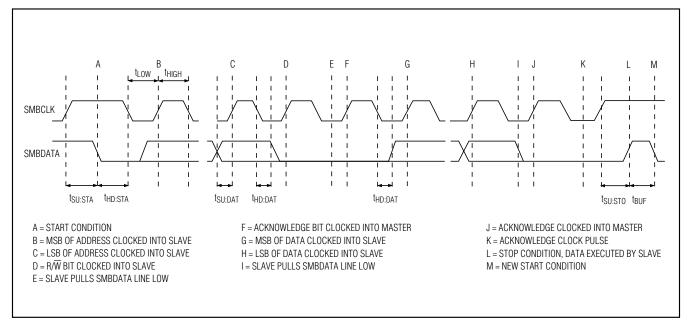


Figure 4. SMBus Write Timing

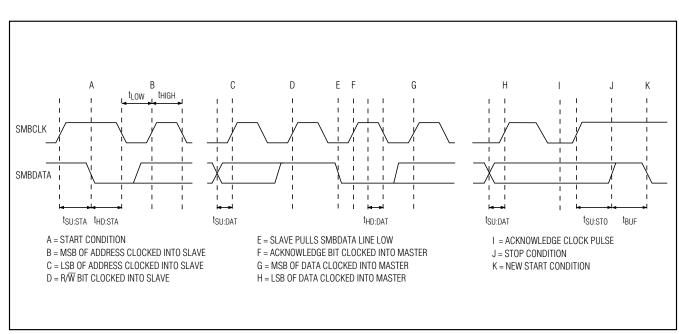


Figure 5. SMBus Read Timing

MAX8731

Table 4. Battery-Charger Command Summary

COMMAND	COMMAND NAME	READ/WRITE	DESCRIPTION	POR STATE
0x14	ChargeCurrent()	Write Only	6-Bit Charge-Current Setting	0x0000
0x15	ChargeVoltage()	Write Only	11-Bit Charge-Voltage Setting	0x0000
0x3F	InputCurrent()	Write Only	6-Bit Charge-Current Setting	0x0080
0xFE	ManufacturerID()	Read Only	Manufacturer ID	0x004D
0xFF	DeviceID()	Read Only	Device ID	0x0008

Battery-Charger Commands

The MAX8731 supports four battery-charger commands that use either Write-Word or Read-Word protocols, as summarized in Table 4. ManufacturerID() and DeviceID() can be used to identify the MAX8731. On the MAX8731, the ManufacturerID() command always returns 0x004D and the DeviceID() command always returns 0x0008.

DC-DC Converter

The MAX8731 employs a synchronous step-down DC-DC converter with an n-channel high-side MOSFET switch and an n-channel low-side synchronous rectifier. The MAX8731 features a pseudo-fixed-frequency, current-mode control scheme with cycle-by-cycle current limit. The controller's constant off-time (tOFF) is calculated based on VCSSP, VCSIN, and a time constant with a minimum value of 300ns. The MAX8731 can also operate in discontinuous-conduction mode for improved light-load efficiency. The operation of the DC-DC controller is determined by the following four comparators as shown in the functional diagrams in Figures 2 and 6:

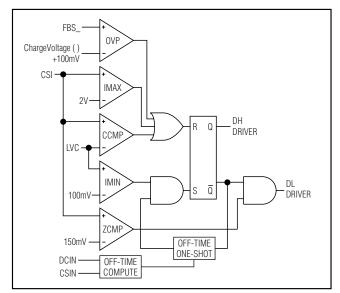


Figure 6. DC-DC Converter Functional Diagram

The **IMIN** comparator triggers a pulse in discontinuous mode when the accumulated error is too high. IMIN compares the control signal (LVC) against 100mV (typ). When LVC is less than 100mV, DHI and DLO are both forced low. Indirectly, IMIN sets the peak inductor current in discontinuous mode.

The **CCMP** comparator is used for current-mode regulation in continuous-conduction mode. CCMP compares LVC against the inductor current. The high-side MOSFET on-time is terminated when the CSI voltage is higher than LVC.

The **IMAX** comparator provides a secondary cycle-bycycle current limit. IMAX compares CSI to 2V (corresponding to 10A when RS2 = $10m\Omega$). The high-side MOSFET on-time is terminated when the current-sense signal exceeds 10A. A new cycle cannot start until the IMAX comparator's output goes low.

The **ZCMP** comparator provides zero-crossing detection during discontinuous conduction. ZCMP compares the current-sense feedback signal to 750mA (RS2 = $10m\Omega$). When the inductor current is lower than the 750mA threshold, the comparator output is high and DLO is turned off.

The **OVP** comparator is used to prevent overvoltage at the output due to battery removal. OVP compares FBS_ against the set voltage (ChargeVoltage()). When FBS_ is 100mV above the set value, the OVP comparator output goes high and the high-side MOSFET on-time is terminated. DHI and DLO remain off until the OVP condition is removed.

CCV, CCI, CCS, and LVC Control Blocks The MAX8731 controls input current (CCS control loop), charge current (CCI control loop), or charge voltage (CCV control loop), depending on the operating condition. The three control loops—CCV, CCI, and CCS—are brought together internally at the lowest voltage-clamp (LVC) amplifier. The output of the LVC amplifier is the feedback control signal for the DC-DC controller. The minimum voltage at the CCV, CCI, or CCS appears at the output of the LVC amplifier and clamps the other control loops to within 0.3V above the control point.



Clamping the other two control loops close to the lowest control loop ensures fast transition with minimal overshoot when switching between different control loops (see the *Compensation* section).

Continuous-Conduction Mode

With sufficient charge current, the MAX8731's inductor current never crosses zero, which is defined as continuous-conduction mode. The regulator switches at 400kHz (nominal) if V_{CSIN} < 0.88 x V_{CSSP}. The controller starts a new cycle by turning on the high-side MOSFET and turning off the low-side MOSFET. When the charge-current feedback signal (CSI) is greater than the control point (LVC), the CCMP comparator output goes high and the controller initiates the off-time by turning off the high-side MOSFET and turning on the low-side MOSFET. The operating frequency is governed by the off-time and is dependent upon V_{CSIN} and V_{CSSP}. The off-time is set by the following equation:

$$t_{OFF} = 2.5 \mu s \times \frac{V_{CSSP} - V_{CSIN}}{V_{CSSP}}$$

The on-time can be determined using the following equation:

$$t_{ON} = \frac{L \times I_{RIPPLE}}{V_{CSSN} - V_{BATT}}$$

where:

$$H_{RIPPLE} = \frac{V_{BATT} \times t_{OFF}}{L}$$

The switching frequency can then be calculated:

$$f_{SW} = \frac{1}{t_{ON} + t_{OFF}}$$

These equations describe the controller's pseudofixed-frequency performance over the most common operating conditions.

At the end of the fixed off-time, the controller initiates a new cycle if the control point (LVC) is greater than 100mV and the peak charge current is less than the cycle-by-cycle current limit. Restated another way, IMIN must be high, IMAX must be low, and OVP must be low for the controller to initiate a new cycle. If the peak inductor current exceeds the IMAX comparator threshold or the output voltage exceeds the OVP threshold, then the on-time is terminated. The cycle-bycycle current limit effectively protects against overcurrent and short-circuit faults.

If during the off-time the inductor current goes to zero, the ZCMP comparator output pulls high, turning off the low-side MOSFET. Both the high- and low-side MOSFETs are turned off until another cycle is ready to begin. ZCOMP causes the MAX8731 to enter into discontinuous-conduction mode (see the *Discontinuous Conduction* section).

There is a 0.3µs minimum off-time when the (VCSSP - VCSIN) differential becomes too small. If VCSIN \geq 0.88 x VCSSP, then the threshold for the 0.3µs minimum off-time is reached. The switching frequency in this mode varies according to the equation:

$$f = \frac{1}{\frac{L \times I_{RIPPLE}}{V_{CSSN} - V_{BATT}} + 0.3 \mu s}$$

Discontinuous Conduction

The MAX8731 can also operate in discontinuous-conduction mode to ensure that the inductor current is always positive. The MAX8731 enters discontinuousconduction mode when the output of the LVC control point falls below 100mV. This corresponds to peak inductor current = 500mA:

$$I_{CHG} = \frac{1}{2} \times \frac{100 \text{mV}}{20 \times \text{RS2}} = 250 \text{mA}$$

charge current for RS2 = $10m\Omega$.

In discontinuous mode, a new cycle is not started until the LVC voltage rises above 100mV. Discontinuousmode operation can occur during conditioning charge of overdischarged battery packs, when the charge current has been reduced sufficiently by the CCS control loop, or when the charger is in constant-voltage mode with a nearly full battery pack.

Compensation

The charge-voltage and charge-current regulation loops are independent and compensated separately at the CCV, CCI, and CCS.

CCV Loop Compensation

The simplified schematic in Figure 7 is sufficient to describe the operation of the MAX8731 when the voltage loop (CCV) is in control. The required compensation network is a pole-zero pair formed with C_{CV} and R_{CV}. The zero is necessary to compensate the pole formed by the output capacitor and the load. R_{ESR} is the equivalent series resistance (ESR) of the charger output capacitor (C_{OUT}). R_L is the equivalent charger output load, where R_L = $\Delta V_{BATT} / \Delta I_{CHG}$. The equivalent output impedance of the GMV amplifier, R_{OGMV}, is greater than 10M Ω . The voltage amplifier transconduc-

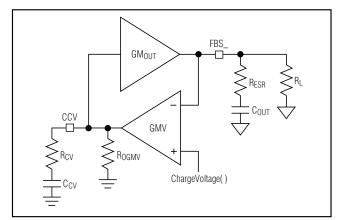


Figure 7. CCV Loop Diagram

Table 5. CCV Loop Poles and Zeros

tance, $GMV = 0.125\mu A/mV$. The DC-DC converter transconductance is dependent upon the charge-current sense resistor RS2:

$$GMOUT = \frac{1}{A_{CSI} \times RS2}$$

where $A_{CSI} = 20V/V$, and $RS2 = 10m\Omega$ in the typical application circuits, so $GM_{OUT} = 5A/V$. The loop-transfer function is given by:

$$\begin{aligned} \mathsf{LTF} &= \mathsf{GM}_{\mathsf{OUT}} \times \mathsf{R}_{\mathsf{L}} \times \mathsf{GMV} \times \mathsf{R}_{\mathsf{OGMV}} \\ &\times \frac{(1 + \mathsf{sC}_{\mathsf{OUT}} \times \mathsf{R}_{\mathsf{ESR}})(1 + \mathsf{sC}_{\mathsf{CV}} \times \mathsf{R}_{\mathsf{CV}})}{(1 + \mathsf{sC}_{\mathsf{CV}} \times \mathsf{R}_{\mathsf{OGMV}})(1 + \mathsf{sC}_{\mathsf{OUT}} \times \mathsf{R}_{\mathsf{L}})} \end{aligned}$$

The poles and zeros of the voltage loop-transfer function are listed from lowest frequency to highest frequency in Table 5.

Near crossover C_{CV} is much lower impedance than R_{OGMV} . Since C_{CV} is in parallel with R_{OGMV} , C_{CV} dominates the parallel impedance near crossover. Additionally, R_{CV} is much higher impedance than C_{CV} and dominates the series combination of R_{CV} and C_{CV} , so near crossover:

$$\frac{R_{OGMV} \times (1 + sC_{CV} \times R_{CV})}{(1 + sC_{CV} \times R_{OGMV})} \cong R_{CV}$$

NAME	EQUATION	DESCRIPTION
CCV Pole	$f_{P_CV} = \frac{1}{2\pi R_{OGMV} \times C_{CV}}$	Lowest frequency pole created by C_{CV} and GMV's finite output resistance.
CCV Zero	$f_{Z_{CV}} = \frac{1}{2\pi R_{CV} \times C_{CV}}$	Voltage-loop compensation zero. If this zero is at the same frequency or lower than the output pole f_{P_OUT} , then the loop-transfer function approximates a single-pole response near the crossover frequency. Choose C_{CV} to place this zero at least 1 decade below crossover to ensure adequate phase margin.
Output Pole	$f_{P_OUT} = \frac{1}{2\pi R_L \times C_{OUT}}$	Output pole formed with the effective load resistance R_L and the output capacitance C_{OUT} . R_L influences the DC gain but does not affect the stability of the system or the crossover frequency.
Output Zero	$f_{P_OUT} = \frac{1}{2\pi R_L \times C_{OUT}}$	Output ESR Zero. This zero can keep the loop from crossing unity gain if f_{Z_OUT} is less than the desired crossover frequency; therefore, choose a capacitor with an ESR zero greater than the crossover frequency.



WAX873

 C_{OUT} is also much lower impedance than R_{L} near crossover so the parallel impedance is mostly capacitive and:

$$\frac{\mathsf{R}_{\mathsf{L}} \cdot}{(1+\mathsf{s}\mathsf{C}_{\mathsf{OUT}} \times \mathsf{R}_{\mathsf{L}})} \cong \frac{1}{\mathsf{s}\mathsf{C}_{\mathsf{OUT}}}$$

If R_{ESR} is small enough, its associated output zero has a negligible effect near crossover and the loop-transfer function can be simplified as follows:

$$LTF = GM_{OUT} \times \frac{R_{CV}}{sC_{OUT}}G_{MV}$$

Setting LTF = 1 to solve for the unity-gain frequency yields:

$$f_{CO_CV} = GM_{OUT} \times G_{MV} \times \frac{R_{CV}}{2\pi \times C_{OUT}}$$

For stability, choose a crossover frequency lower than 1/10 the switching frequency. For example, choose a crossover frequency of 50kHz and solve for Rvc using the component values listed in Figure 1 to yield $R_{CV} = 10k\Omega$:

$$R_{CV} = \frac{2\pi \times C_{OUT} \times f_{CO_CV}}{GMV \times GM_{OUT}} \cong 10k\Omega$$

 $GMV = 0.125 \mu A/mV$

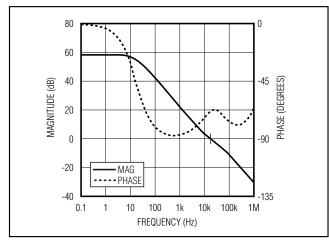


Figure 8. CCV Loop Response

 $GM_{OUT} = 5A/V$ $C_{OUT} = 2 \times 10\mu F$ $F_{OSC} = 400 kHz$ $R_L = 0.2\Omega$ $F_{CO_CV} = 50 kHz$ To ensure that the

To ensure that the compensation zero adequately cancels the output pole, select fz_Cv \leq fp_OUT:

 $C_{CV} \geq 400 pF$ (assuming 2 cells and 2A maximum charge current.)

Figure 8 shows the Bode plot of the voltage-loop frequency response using the values calculated above.

CCI Loop Compensation

The simplified schematic in Figure 9 is sufficient to describe the operation of the MAX8731 when the battery current loop (CCI) is in control. Since the output capacitor's impedance has little effect on the response of the current loop, only a simple single pole is required to compensate this loop. ACSI is the internal gain of the current-sense amplifier. RS2 is the charge current-sense resistor (10m Ω). ROGMI is the equivalent output impedance of the GMI amplifier, which is greater than 10M Ω . GMI is the charge-current amplifier transconductance = 1µA/mV. GMOUT is the DC-DC converter transconductance = 5A/V.

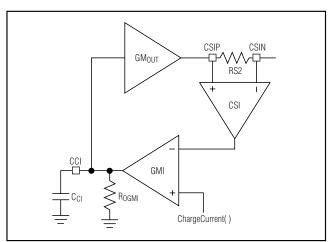


Figure 9. CCI Loop Diagram